Express Mail No. EV622661568US

Attorney Docket No. 108298404US2 Disclosure No. 99-319.02/US

AMENDMENT TRANSMITTAL LETTER								Docket No. 108298404US2		
Application No.			Filing [	-	Examiner		Art Unit			
10/772,541-Conf. #8900			February 5, 2004		Y. T. Tadess		e 1734			
Applicant(s): Agarwal et al.										
nvention: METHOD AND APPARATUS FOR FORMING A PLANARIZING PAD FOR PLANARIZATION OF MICROELECTRONIC SUBSTRATES										
TO THE COMMISSIONER FOR PATENTS										
Transmitted herewith is an amendment in the above-identified application.										
The fee has been calculated and is transmitted as shown below.										
CLAIMS AS AMENDED										
		Claims Remaining After Amendment	Highest Number Number Previously Extra Clair Paid Present		Rate			ray si		
	tal Claims	17	- 20 =	0	Х					
	ependent ims	4	- 3 =	1	×	200.00		200.00		
Multiple Dependent Claims (check if applicable)										
Other fee (please specify): Extension for response within second month							450.00			
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT:							650.00			
x	x Large Entity Small Entity									
No additional fee is required for this amendment.										
Please charge Deposit Account No in the amount of \$ A duplicate copy of this sheet is enclosed.										
X A check in the amount of \$ 650.00 to cover the filing fee is enclosed.										
Payment by credit card. Form PTO-2038 is attached.										
The Director is hereby authorized to charge and credit Deposit Account No										
x Credit any overpayment.										
Charge approach additional filing or application processing fees required under 37 CFR 1.16 and 1.17.										
Dated: September 6, 2005  David T. Dutcher  Attorney Reg. No.: 51,638										
PERKINS COIE LLP P.O. Box 1247 Seattle, Washington 98111-1247 (206) 359-8000										
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## **PATENT**

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF:

VISHNU K. AGARWAL AND

DINESH CHOPRA

**APPLICATION NO.:** 

10/772,541

FILED:

For:

**FEBRUARY 5, 2004** 

APPARATUSES FOR FORMING A

PLANARIZING PAD FOR PLANARIZATION OF

**MICROELECTRONIC SUBSTRATES** 

EXAMINER: '

YEWEBDAR T.

**TADESSE** 

ART UNIT:

1734

CONF. No:

8900

## Amendment Under 37 C.F.R. § 1.111

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

The present communication responds to the Office Action dated April 5, 2005 in the above-identified application. Please extend the period of time for response to this Office Action by two months, to expire September 5, 2005. Please amend the application as follows:

Amendments to the Specification begin on page 2.

Amendments to the Claims are reflected in the listing of claims beginning on page 3.

09/09/2005 MAHMED1 00000049 10772541

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